1PS70SB10

Schottky barrier single diode

17 December 2012

Product data sheet

1. General description

Planar Schottky barrier diode with an integrated guard ring for stress protection, encapsulated in a very small SOT323 Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Low forward voltage
- Low capacitance
- AEC-Q101 qualified

3. Applications

- Ultra high-speed switching
- Line termination
- Voltage clamping
- Reverse polarity protection

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _F	forward current		-	-	200	mA
V_R	reverse voltage		-	-	30	V
V _F	forward voltage	I _F = 10 mA; T _{amb} = 25 °C	-	-	400	mV

5. Pinning information

Table 2. Pinning information

TUDIC Z.	9	IIIIOIIIIaaoii		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	А	anode	<u> </u>	K
2	n.c.	not connected		A n.c.
3	K	cathode	1 2	aaa-005805
			SC-70 (SOT323)	





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6. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
1PS70SB10	SC-70	plastic surface-mounted package; 3 leads	SOT323			

7. Marking

Table 4. Marking codes

Type number	Marking code [1]
1PS70SB10	7%0

^{[1] % =} placeholder for manufacturing site code

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _R	reverse voltage		-	30	V
I _F	forward current		-	200	mA
I _{FRM}	repetitive peak forward current	$t_p \le 1 \text{ s}; \ \delta \le 0.5$	-	300	mA
I _{FSM}	non-repetitive peak forward current	t_p < 10 ms; $T_{j(init)}$ = 25 °C	-	600	mA
P _{tot}	total power dissipation	T _{amb} < 25 °C	-	200	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-55	150	°C
T _{stg}	storage temperature		-65	150	°C

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1]	-	-	625	K/W

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

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10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _F forwa	forward voltage	I _F = 0.1 mA; T _{amb} = 25 °C	-	-	240	mV
		I _F = 1 mA; T _{amb} = 25 °C	-	-	320	mV
		I _F = 10 mA; T _{amb} = 25 °C	-	-	400	mV
		I _F = 30 mA; T _{amb} = 25 °C	-	-	500	mV
		I _F = 100 mA; T _{amb} = 25 °C	-	-	800	mV
I _R	reverse current	V_R = 25 V; pulsed; t_p = 300 µs; δ = 0.02 ; T_{amb} = 25 °C	-	-	2	μA
C _d	diode capacitance	V _R = 1 V; f = 1 MHz; T _{amb} = 25 °C	-	-	10	pF

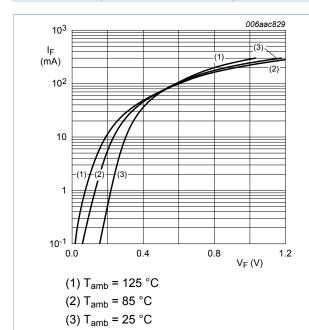
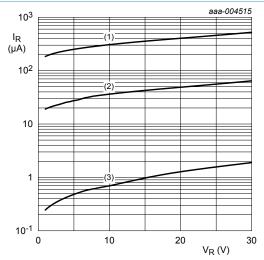


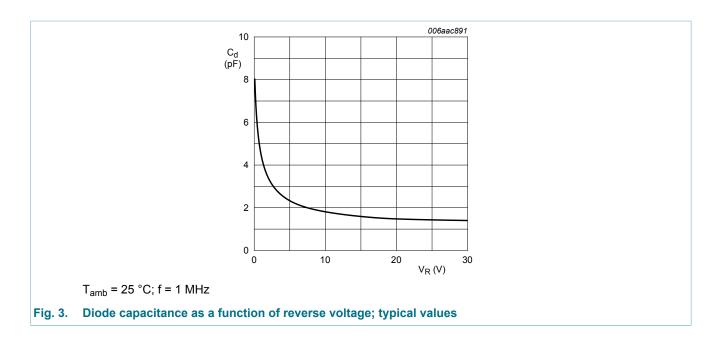
Fig. 1. Forward current as a function of forward voltage; typical values



- (1) T_{amb} = 125 °C
- (2) $T_{amb} = 85 \, ^{\circ}C$
- $(3) T_{amb} = 25 °C$

Fig. 2. Reverse current as a function of reverse voltage; typical values

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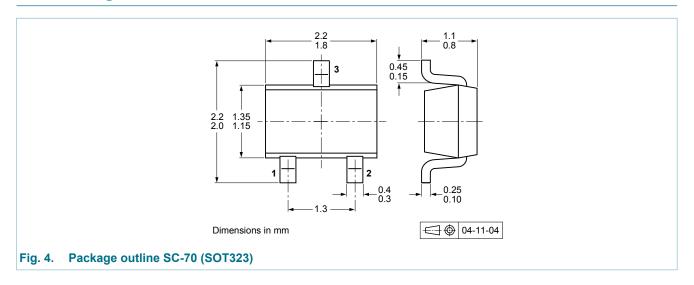


11. Test information

11.1 Quality information

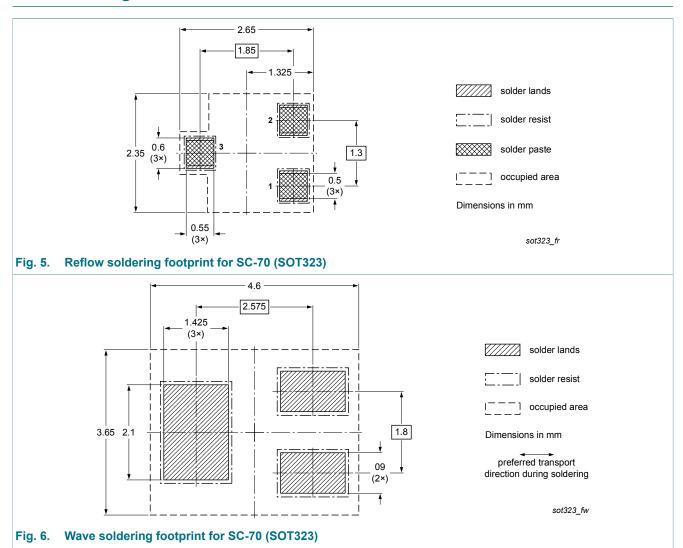
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



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13. Soldering



14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
1PS70SB10 v.2	20121217	Product data sheet	-	1PS70SB10_14_15_16 v.1

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Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
Modifications:	of NXP Semiconduct Legal texts have be Sections 1 to 3 upds Section 4 "Quick ref Section 6 "Ordering Section 7 "Marking" Table 5 "Limiting va value updated Figues 1, 2 and 3 updated Section 11 "Test info	etors. en adapted to the new conted ference data" added information" added updated lues": ambient temperature pdated primation" added ed by minimized package ing" added	igned to comply with the ompany name where appeare T _{amb} and junction temoral outline drawing	ropriate.
1PS70SB10_14_15_16 v.1	19990426	Product data sheet	-	-

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15. Legal information

15.1 Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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Date of release: 17 December 2012